

serial	Name	Specifications	Num	A no.	material
1	PCB	SH805C V1.0,0.8mm	1		44-009-00505
2	resistance	0Ω,CHIP,0402,J1/16W,+/-5%	2	R25.R27	44-006-00001
3	resistance	2.2Ω,0402,SMD,±5%	1	R23	44-006-00002
4	resistance	10Ω,0402,SMD,±5%	1	R21	44-006-00006
5	resistance	1KΩ,0402,SMD,±5%	1	R8	44-006-00009
6	resistance	2.2KΩ,0402,SMD,±5%	1	R11	44-006-00037
7	capacitance	1.2PF,0402,50V,±5%	1	C23	44-007-00139
8	capacitance	15PF,0402,50V,5%,NPO	1	C9	44-007-00066
9	capacitance	33PF,0402,50V,5%,NPO	3	C14.C15.C17	44-007-00071
10	capacitance	0.1uF,0402,16V,10%,X5R	7	C6.C12.C18.C19.C20.C26.C32	44-007-00096
11	capacitance	1uF,0402,6.3V,10%,X5R	3	C1.C24.C28	44-007-00099
12	capacitance	2.2uF,0402,6.3V,±20% ,X5R	2	C3.C4	44-007-00102
13	capacitance	4.7uF,0603,6.3V,10%,X5R	2	C10.C13	44-007-00115
14	capacitance	10uF,0603,6.3V,20%,X5R	2	C2.C29	44-007-00109
15	inductance	1.5nH,CHIP,0402,+/-5%,	1	L5	44-008-00048
16	inductance	1nH,CHIP,0402,+/-5%	1	L4	44-008-00007
17	inductance	6.8nH,CHIP,0402,+/-5%	1	L2	44-008-00019
18	inductance	15nH,CHIP,0402,+/-5%	1	L3	44-008-00021
19	inductance	120nH,CHIP,0402,+/-5%	2	R26.R28	44-008-00049
20	inductance	10uH,CHIP,0805,+/-5%,GLFR2012T100M-LR	1	L1	44-008-00001
21	diodes	SMD,0603	1	D2	44-003-000

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22	diodes	SMD,0603	1	D1	44-003-000 18
23	IC	QFN,6x6mm,AB1513,V3.0+EDR,	1	U1	44-001-000 92
24	IC	EEPROM,128K,TSSOP-8	1	U12	44-001-000 31
25	crystals	16MHz,SMD SEALING *TAL3.2*2.5,±10ppm,capacitance9P	1	CY1	44-010-000 08
26	Ant	RFANT5220110A0T ISM 2.4-2.5GHz	1	ANT1	44-025-000 11
27	socket	micro USB 5PIN,	1	USB1	44-012-000 50
28	Button	4.7*2.3*1.9mm,160g,side-pushing,swit ch 2*4	3	SW1.SW2.SW3	44-011-000 47